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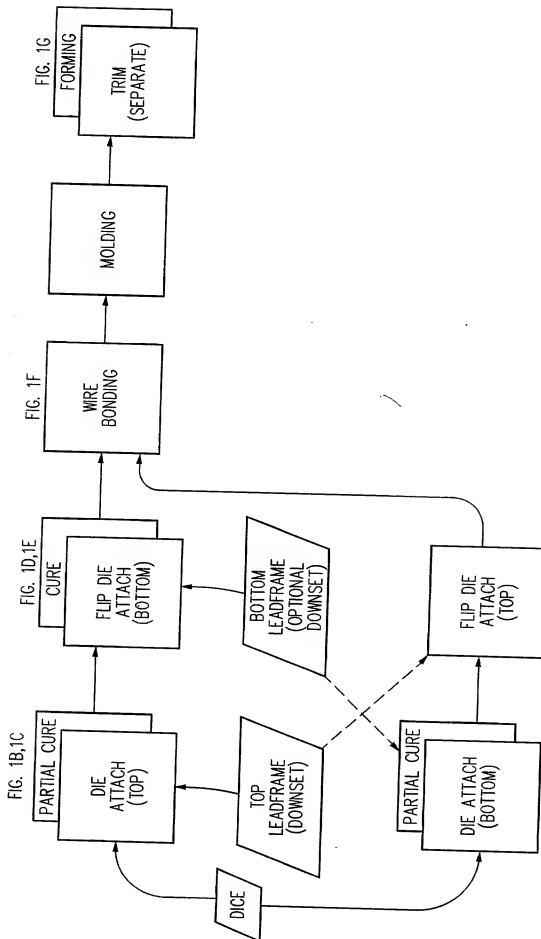


FIG. 1A
(PRIOR ART)

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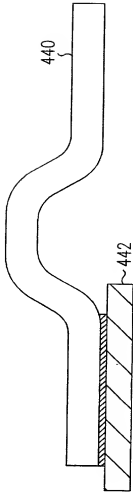


FIG. 1B
(PRIOR ART)

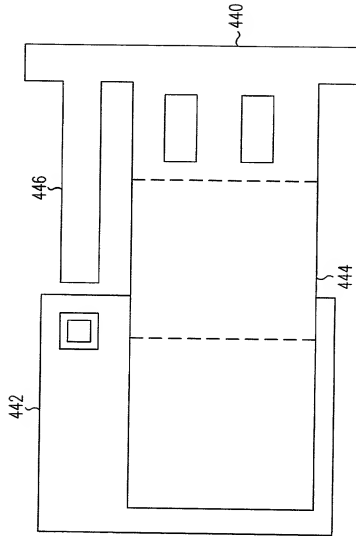


FIG. 1C
(PRIOR ART)

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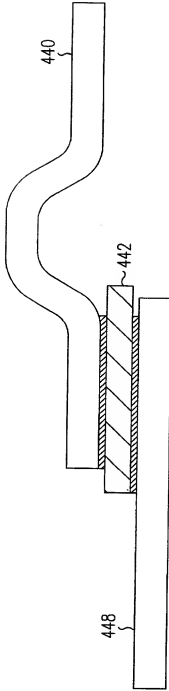


FIG. 1D
(PRIOR ART)

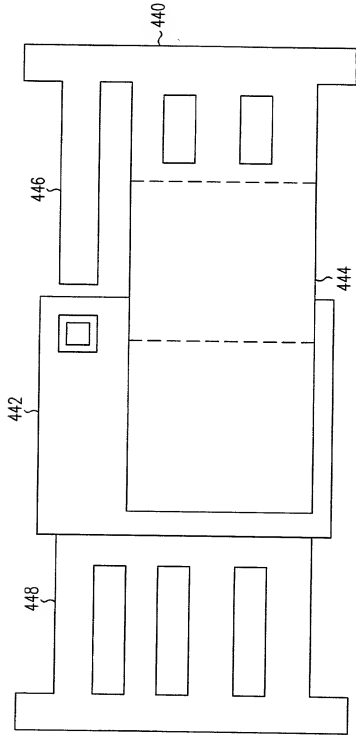
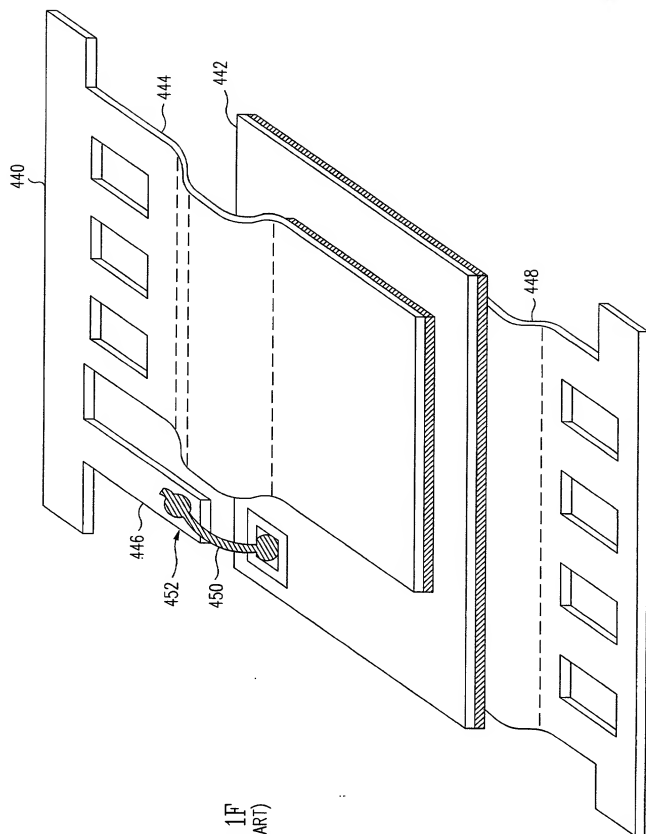
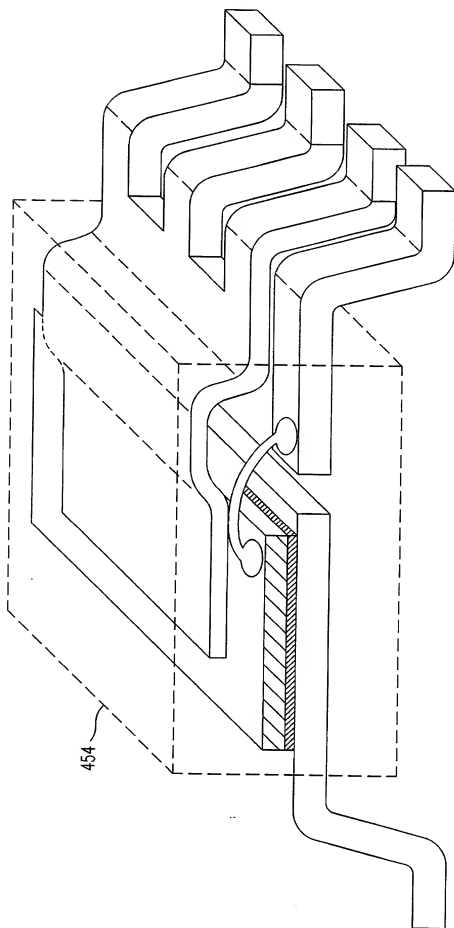


FIG. 1E
(PRIOR ART)

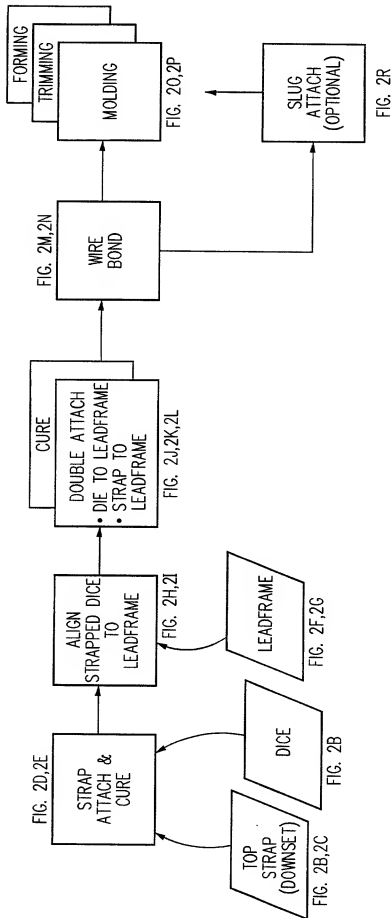
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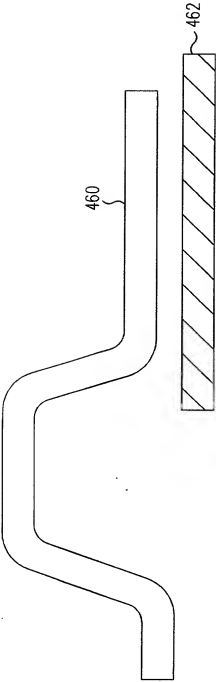


FIG. 2B
(PRIOR ART)

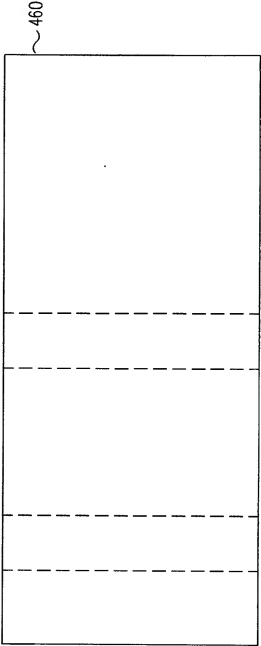


FIG. 2C
(PRIOR ART)

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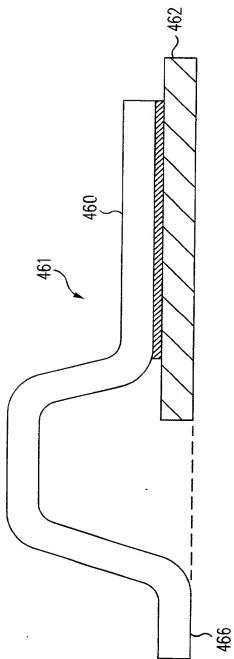


FIG. 2D
(PRIOR ART)

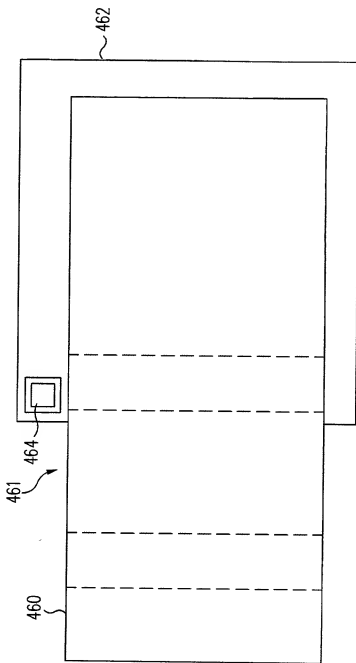
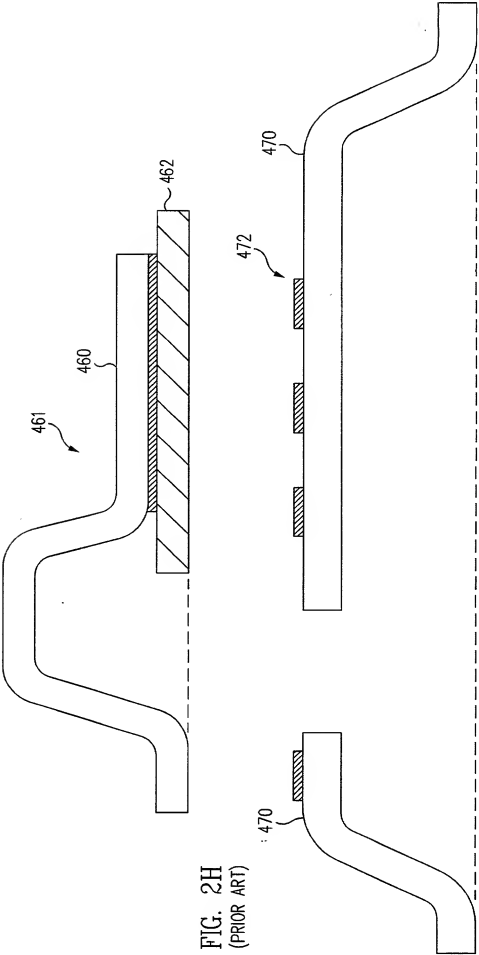


FIG. 2E
(PRIOR ART)



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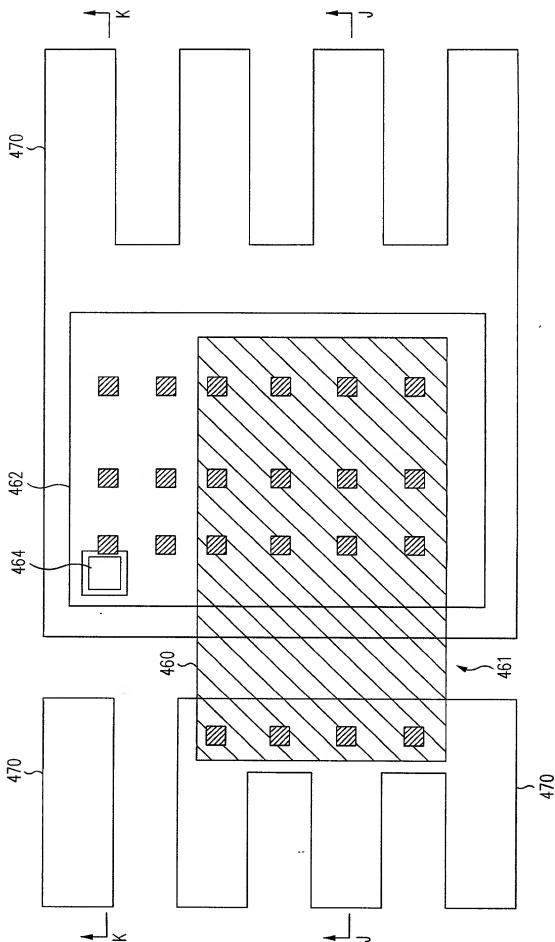


FIG. 21
(PRIOR ART)

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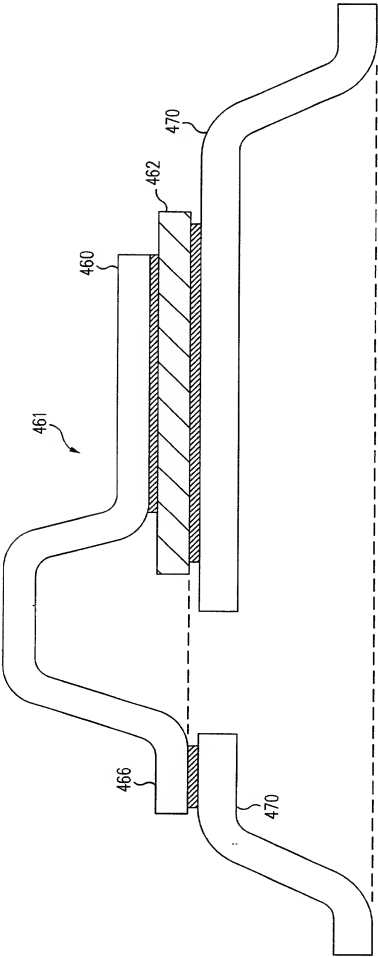


FIG. 2J
(PRIOR ART)

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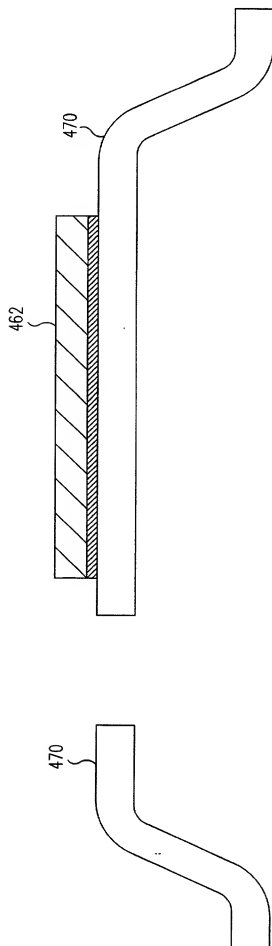


FIG. 2K
(PRIOR ART)

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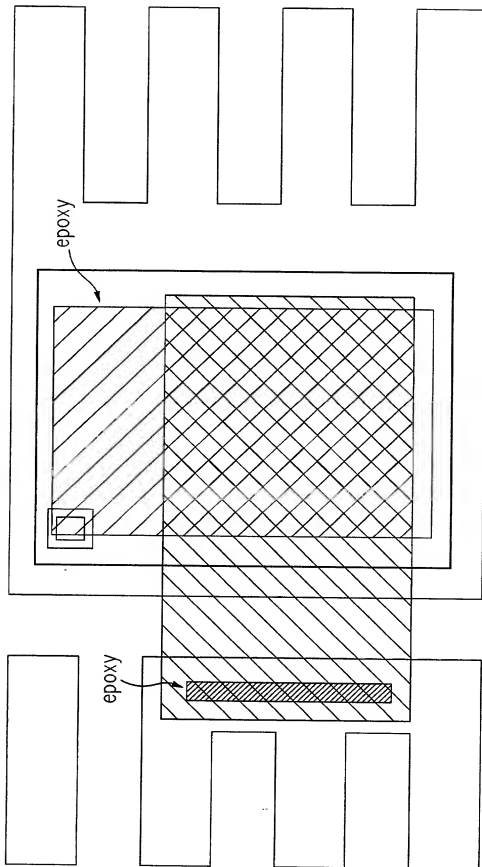


FIG. 2L
(PRIOR ART)

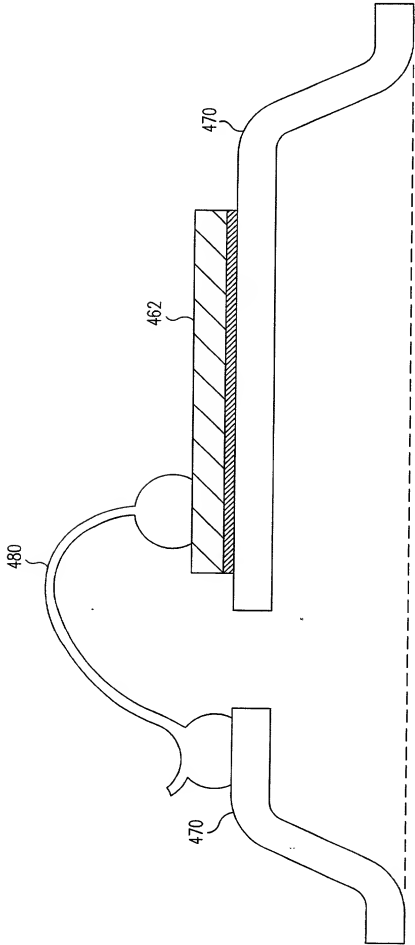


FIG. 2M
(PRIOR ART)

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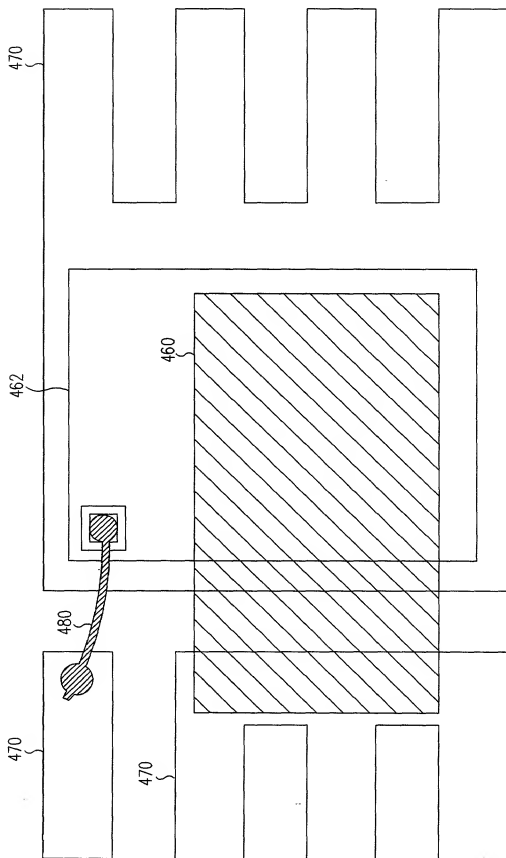


FIG. 2N
(PRIOR ART)

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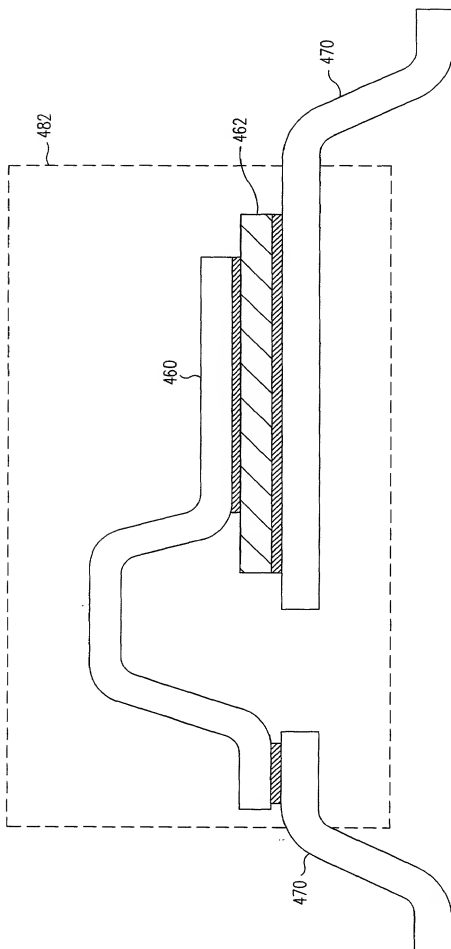


FIG. 20
(PRIOR ART)

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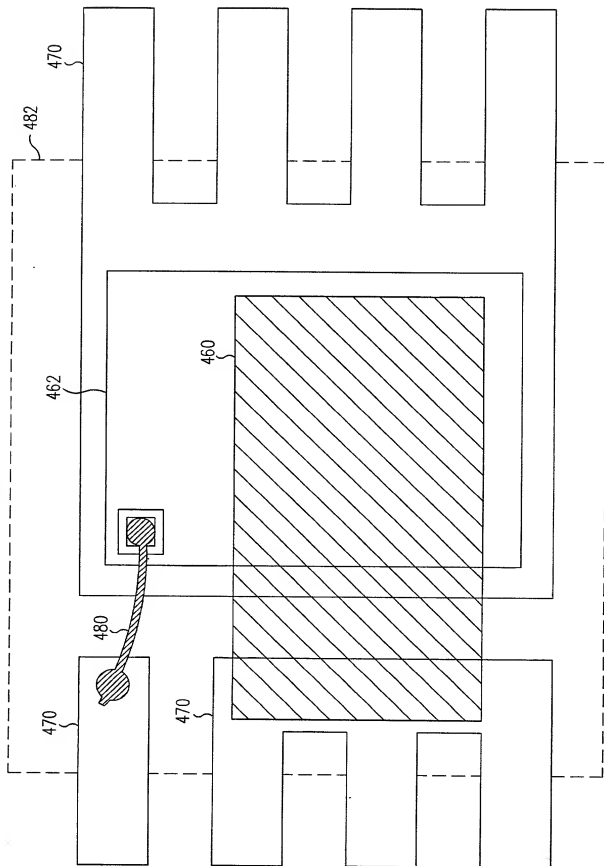


FIG. 2P
(PRIOR ART)

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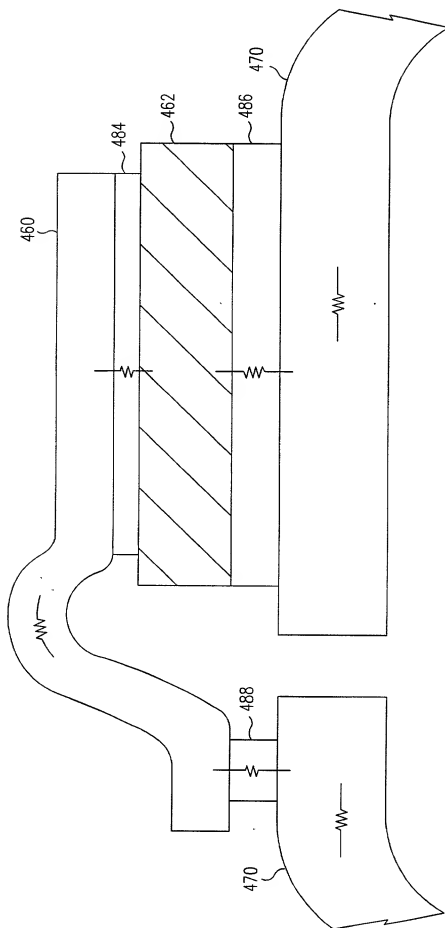


FIG. 2Q
(PRIOR ART)

[illegible]

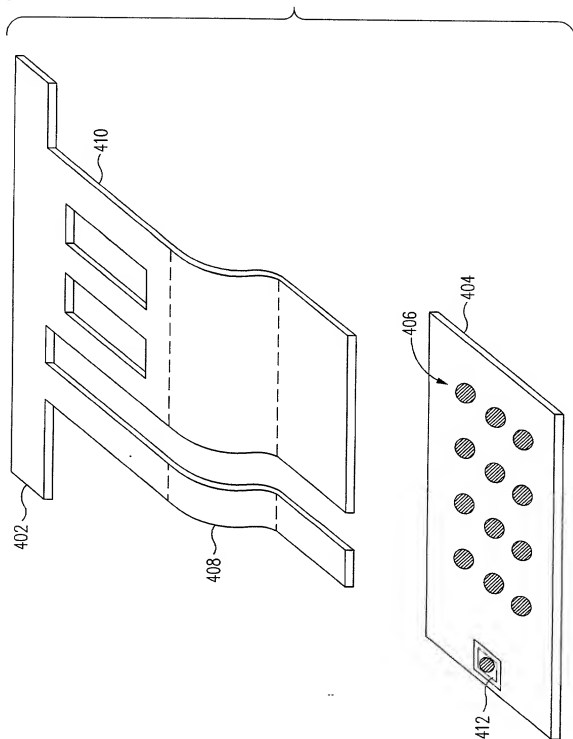


FIG. 3A
(PRIOR ART)

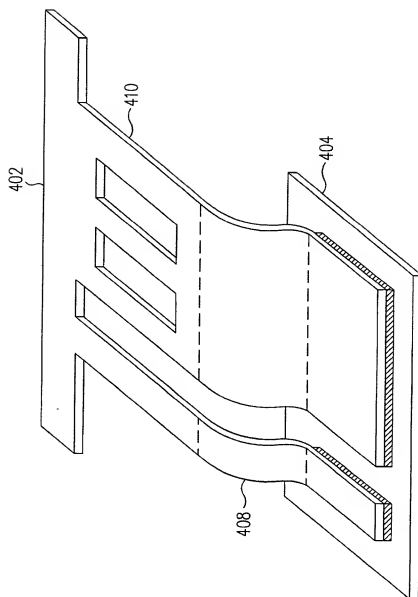


FIG. 3B
(PRIOR ART)

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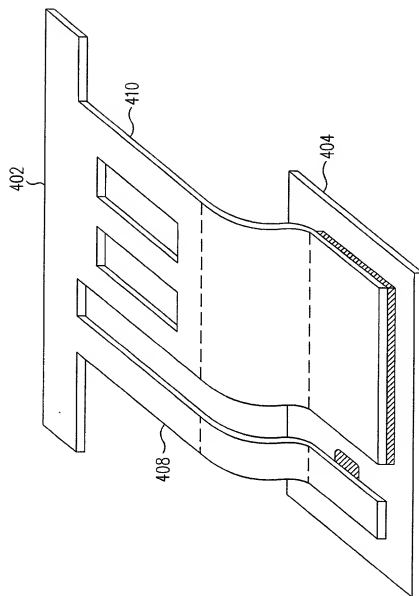


FIG. 3C
(PRIOR ART)

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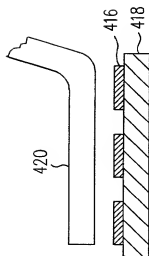


FIG. 3E
(PRIOR ART)

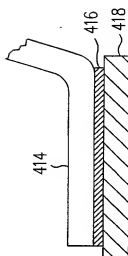


FIG. 3D
(PRIOR ART)

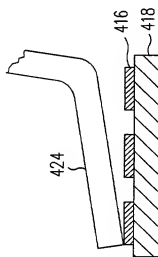


FIG. 3G
(PRIOR ART)

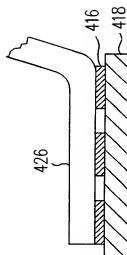


FIG. 3H
(PRIOR ART)

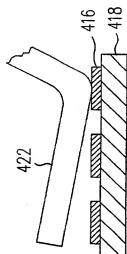


FIG. 3F
(PRIOR ART)

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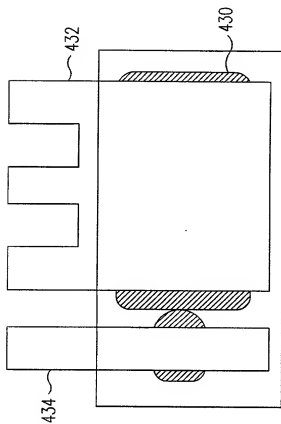


FIG. 4B
(PRIOR ART)

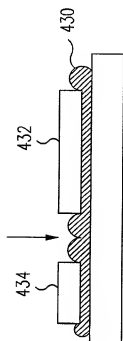


FIG. 4A
(PRIOR ART)

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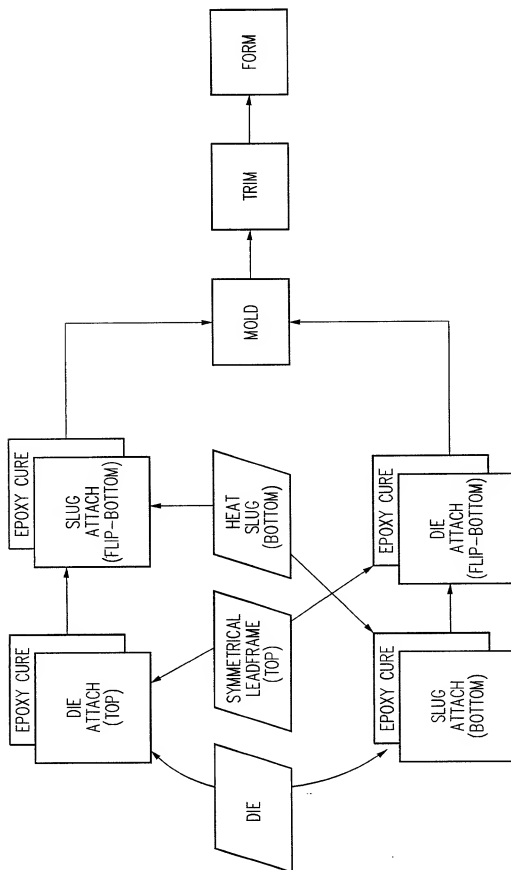
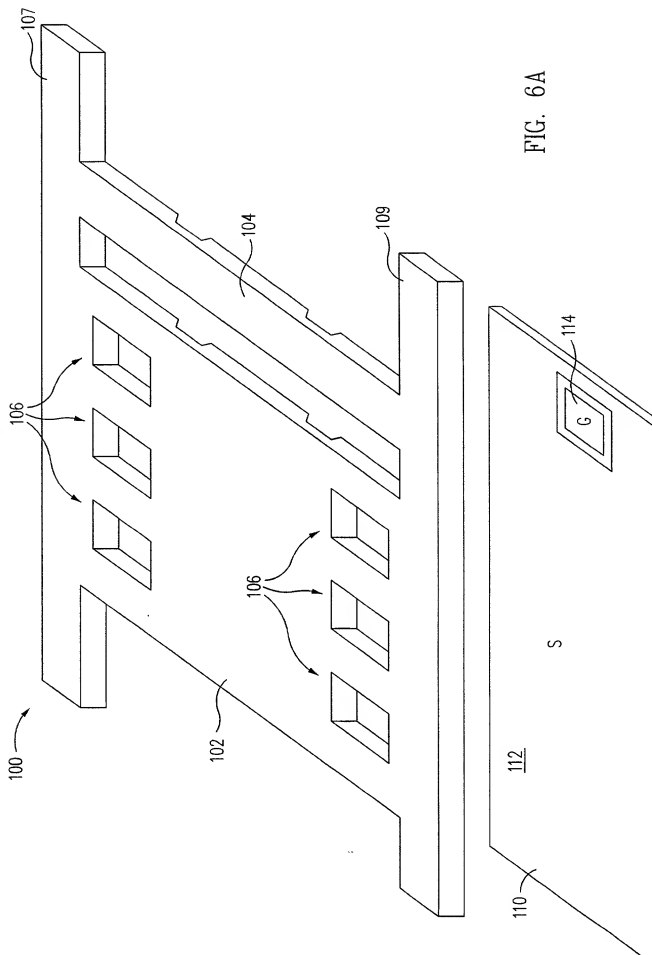
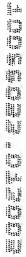


FIG. 5

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[illegible]

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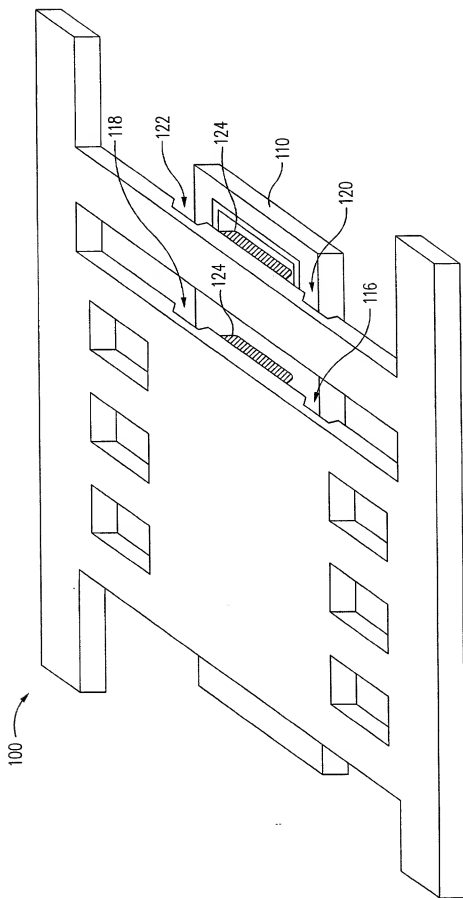


FIG. 6C

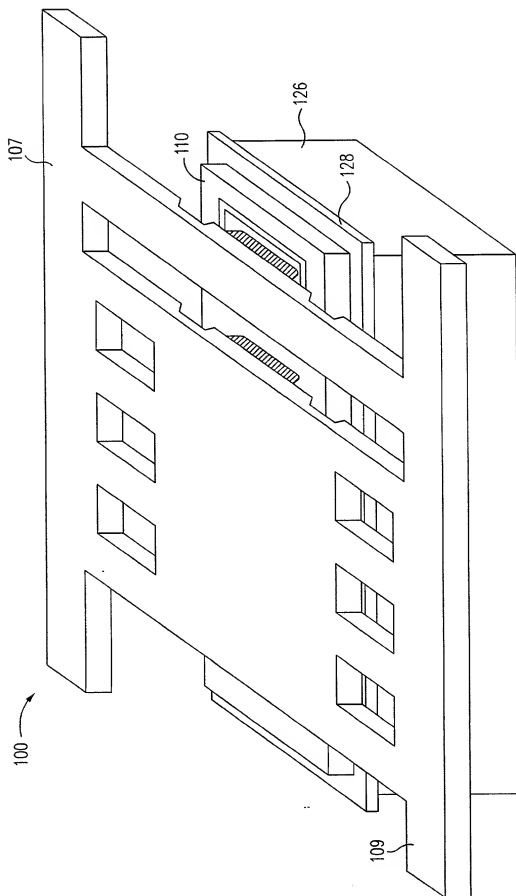


FIG. 6D

Symmetrical Package For Semiconductor Die
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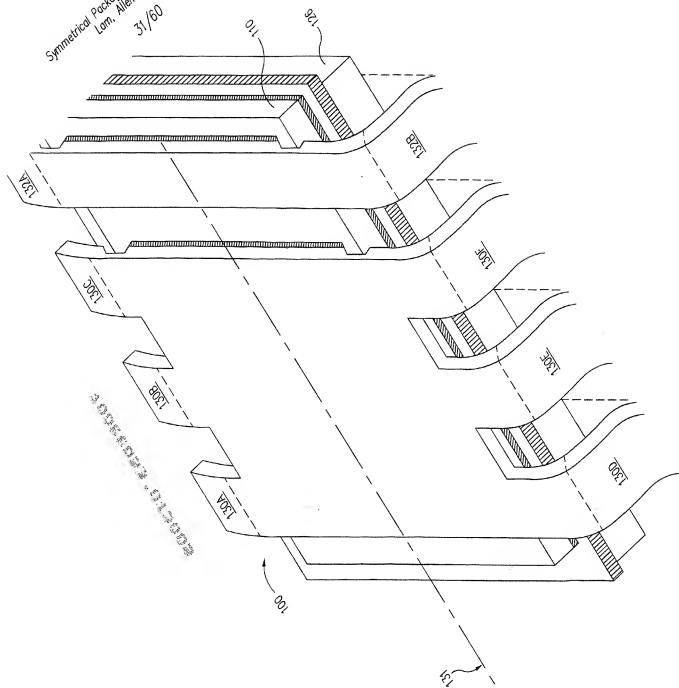


FIG. 6E

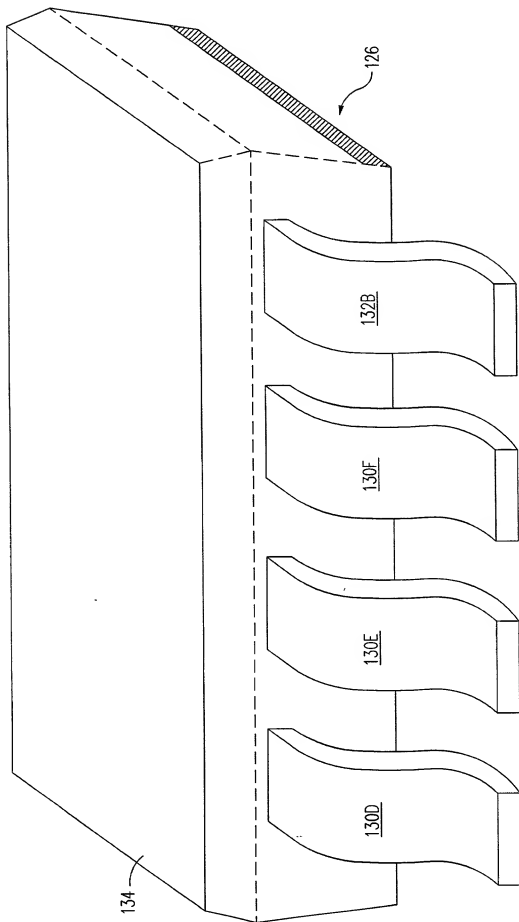


FIG. 6F

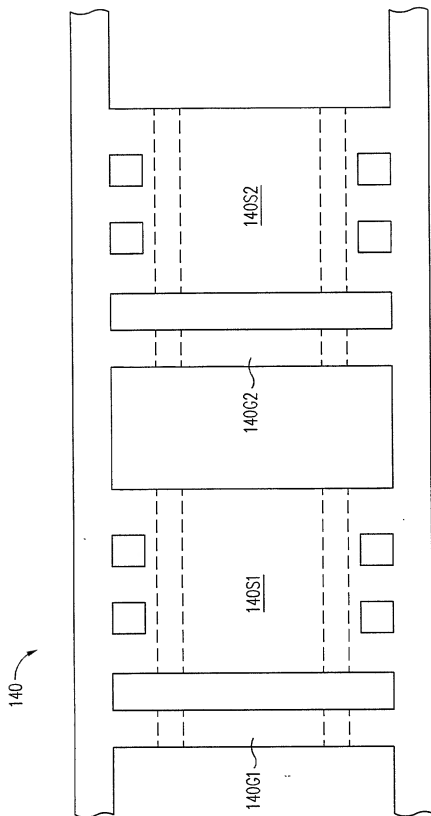


FIG. 7A

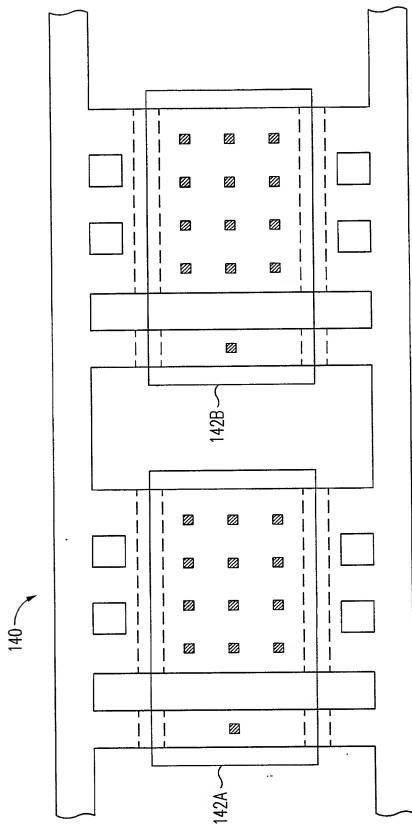


FIG. 7B

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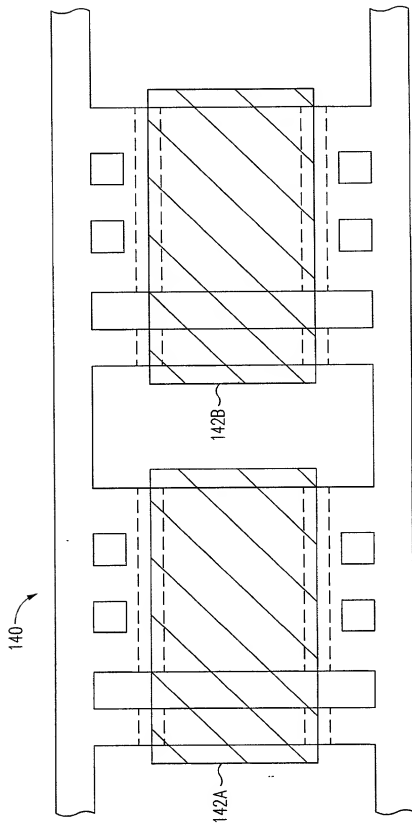


FIG. 7C

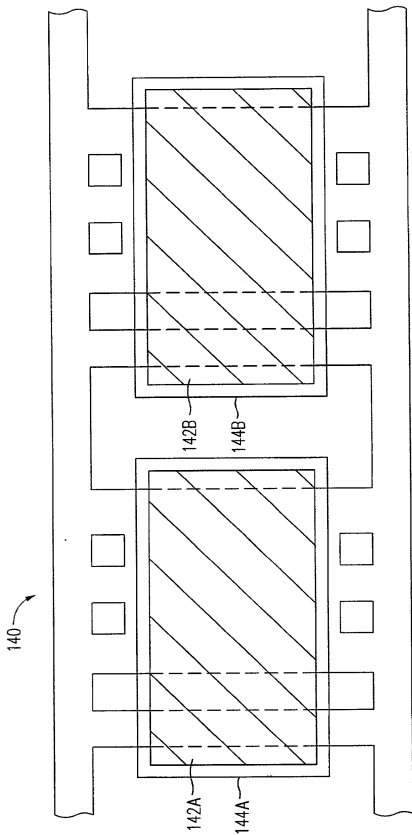


FIG. 7D

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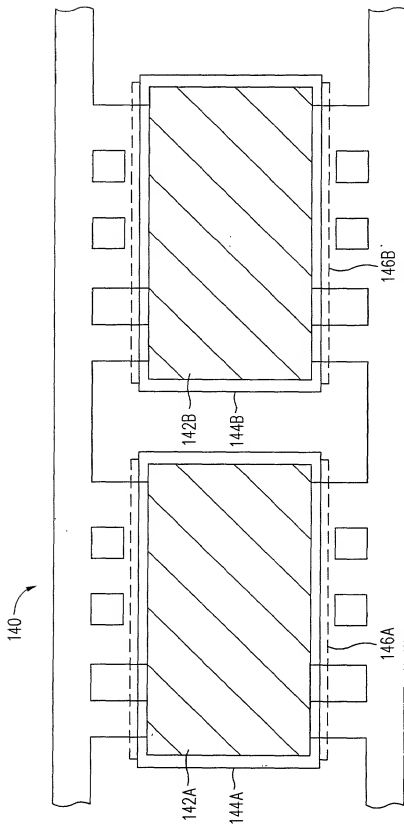


FIG. 7E

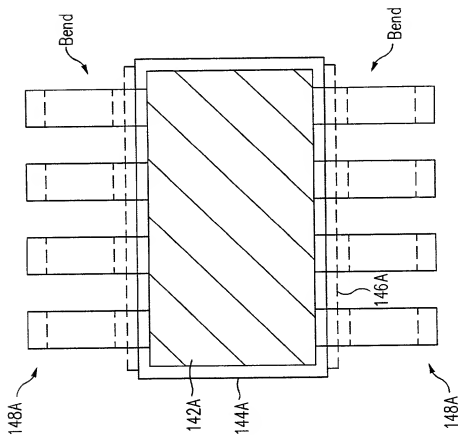


FIG. 7G

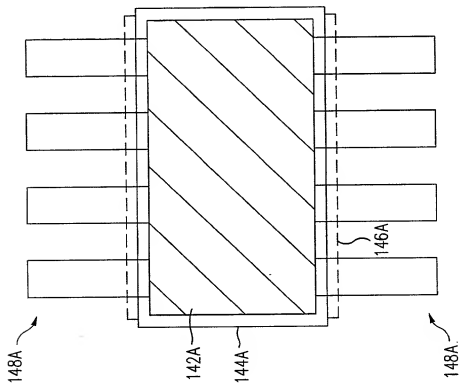


FIG. 7F

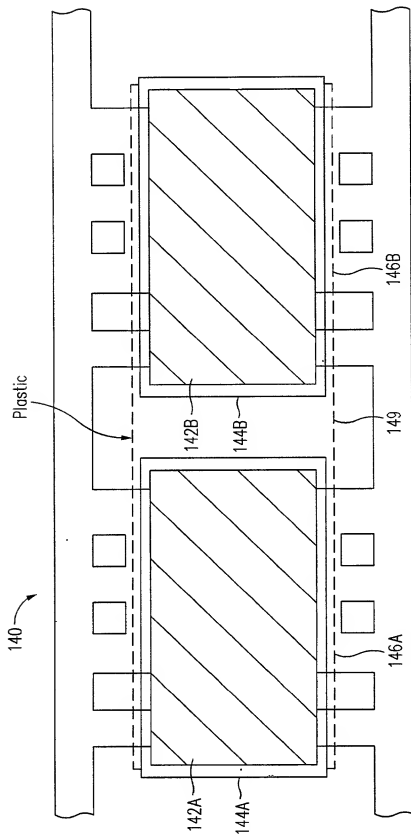


FIG. 7H

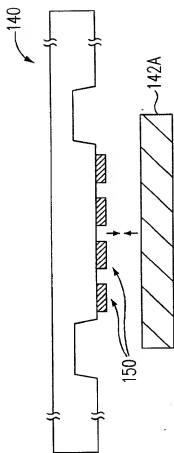


FIG. 8A

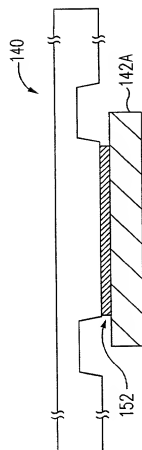


FIG. 8B

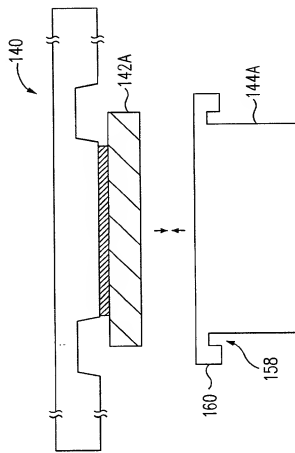


FIG. 8C

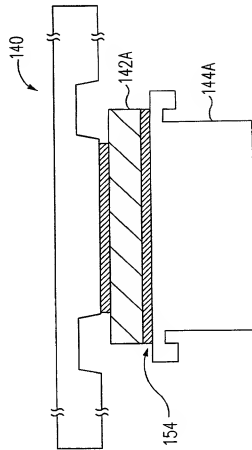


FIG. 8D

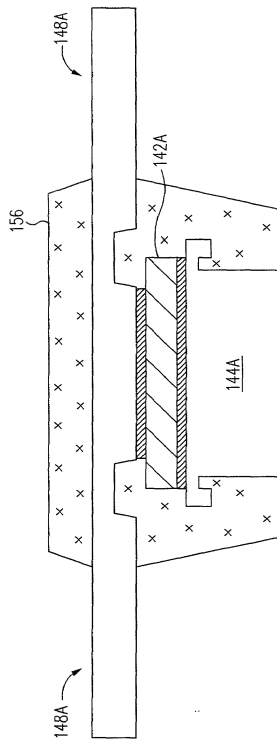


FIG. 8E

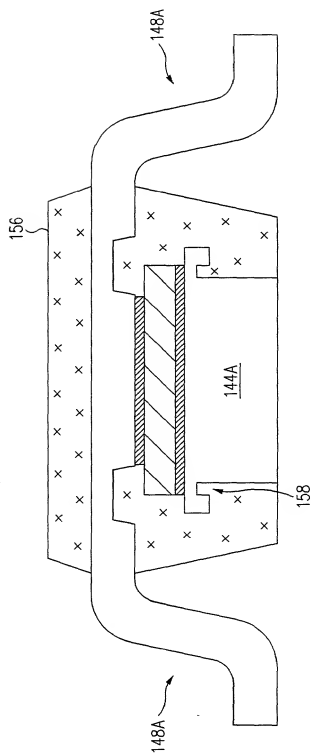


FIG. 8F

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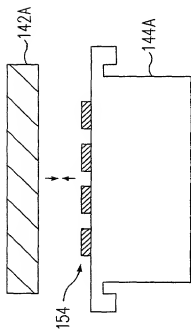


FIG. 8G

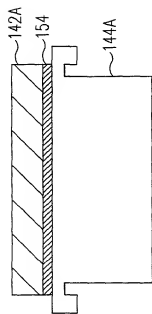


FIG. 8H

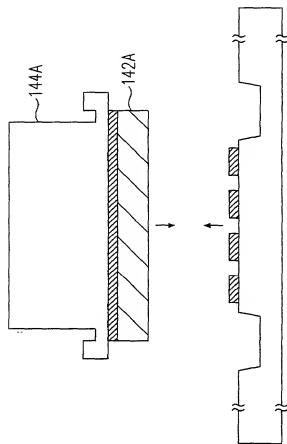


FIG. 8I

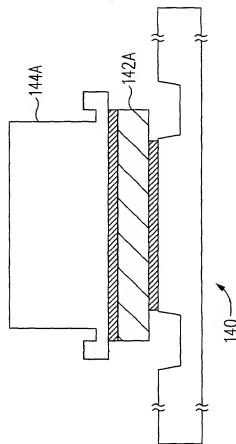


FIG. 8J

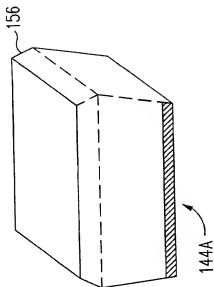


FIG. 9C

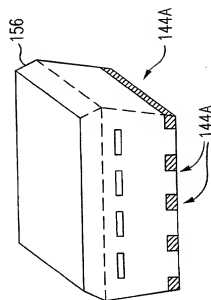


FIG. 9D

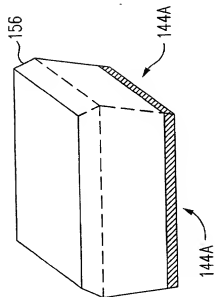


FIG. 9A

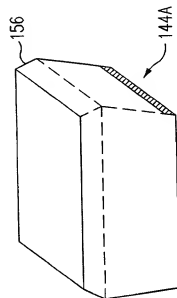


FIG. 9B

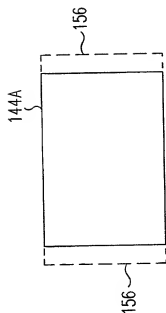


FIG. 9G

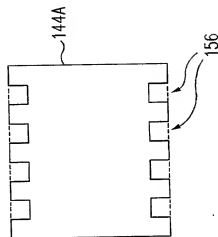


FIG. 9H

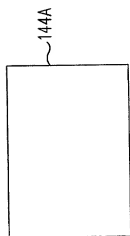


FIG. 9E

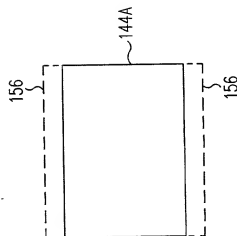


FIG. 9F

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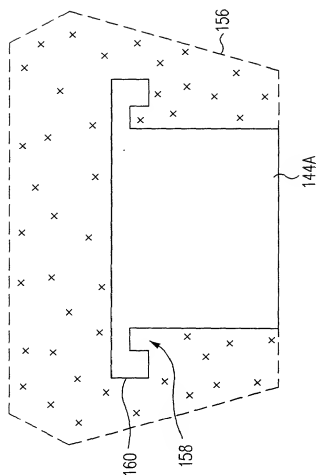


FIG. 10A

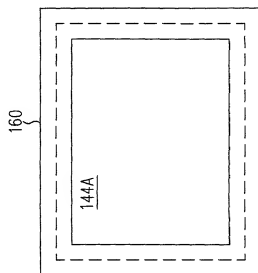


FIG. 10B

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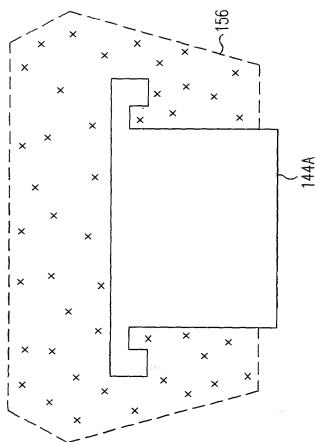


FIG. 10C

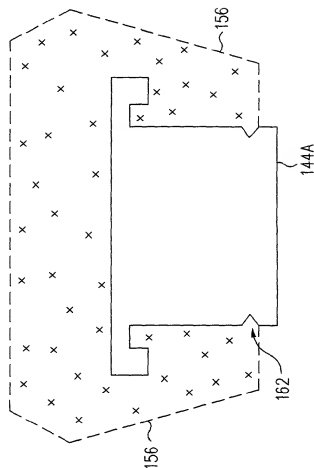


FIG. 10D

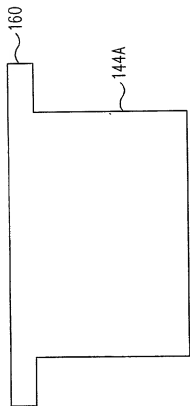


FIG. 10E

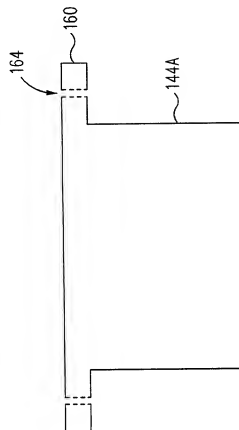


FIG. 10F

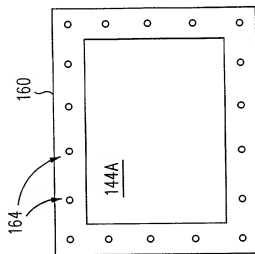


FIG. 10G

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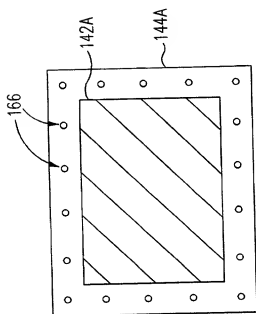


FIG. 10I

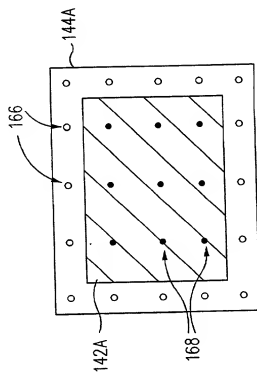


FIG. 10K

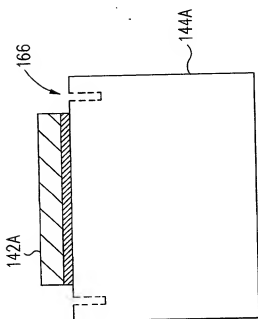


FIG. 10H

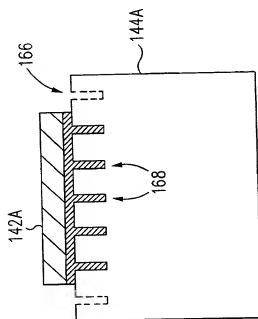


FIG. 10J

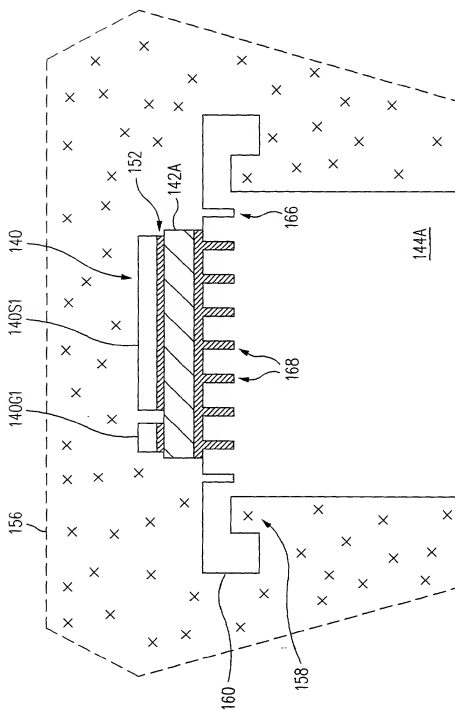


FIG. 10L

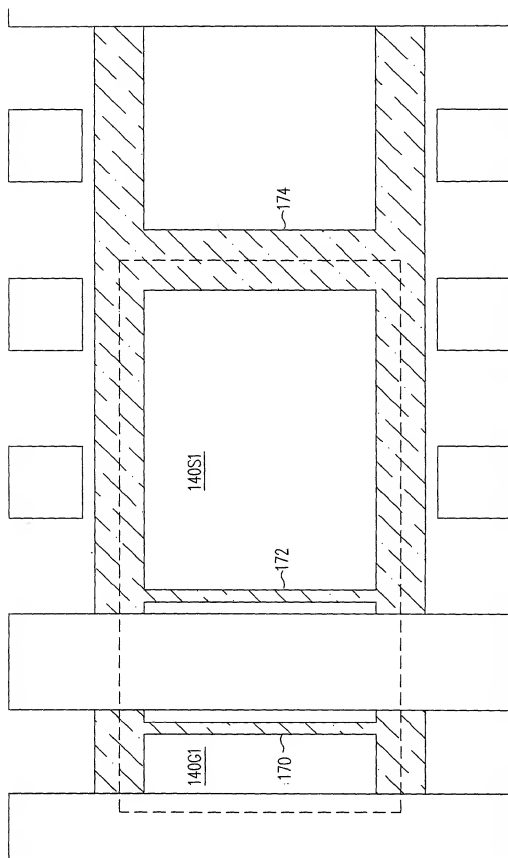
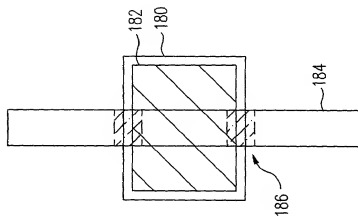
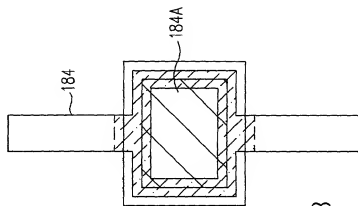
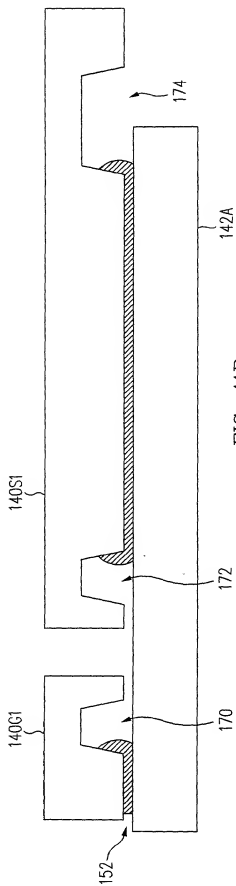


FIG. 11A



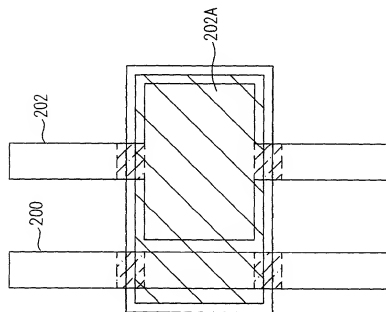


FIG. 12D

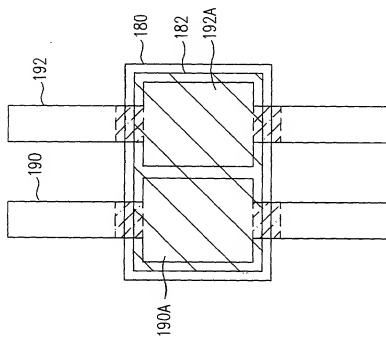


FIG. 12C

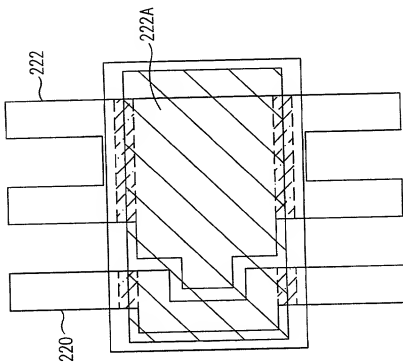


FIG. 12F

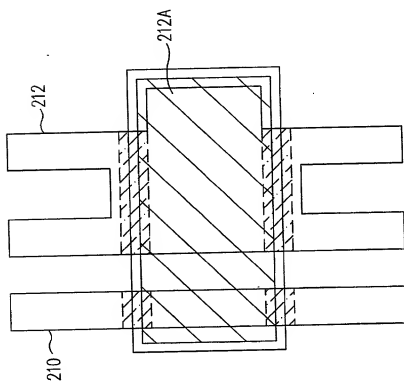


FIG. 12E

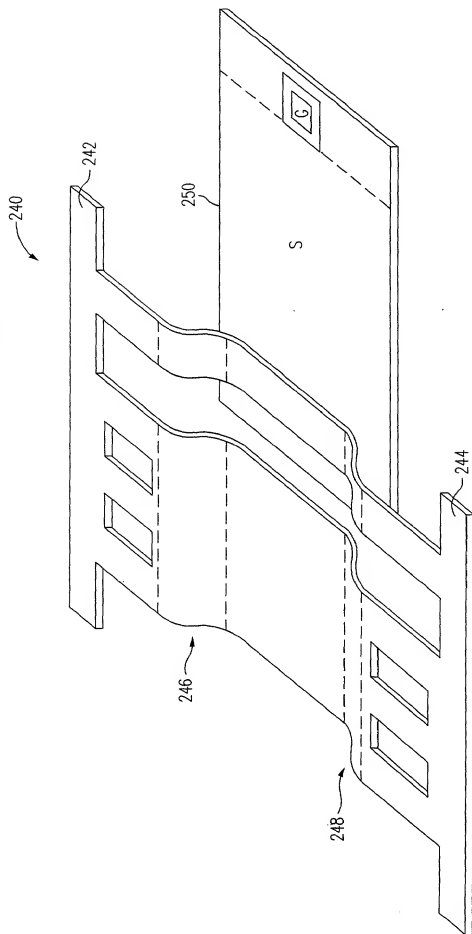


FIG. 13A

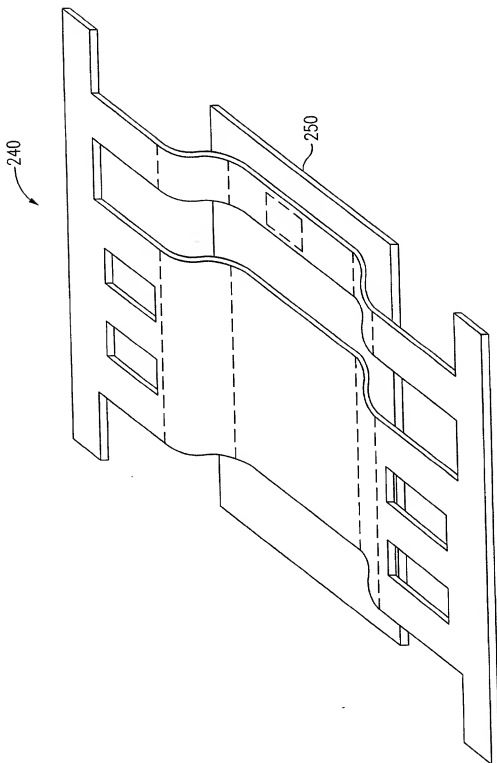


FIG. 13B

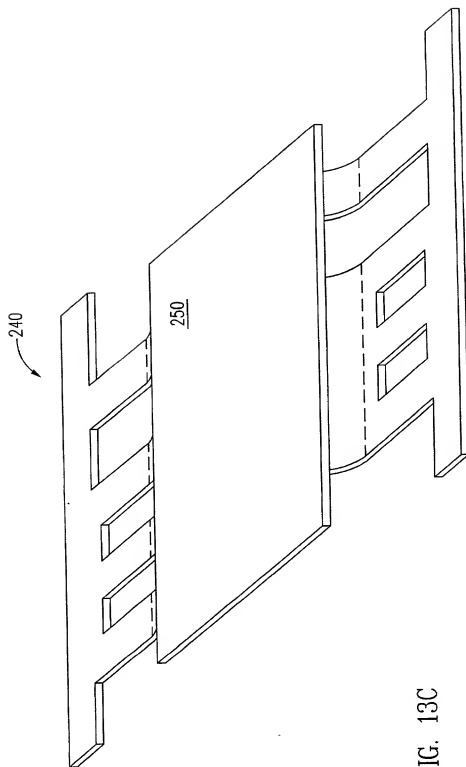


FIG. 13C

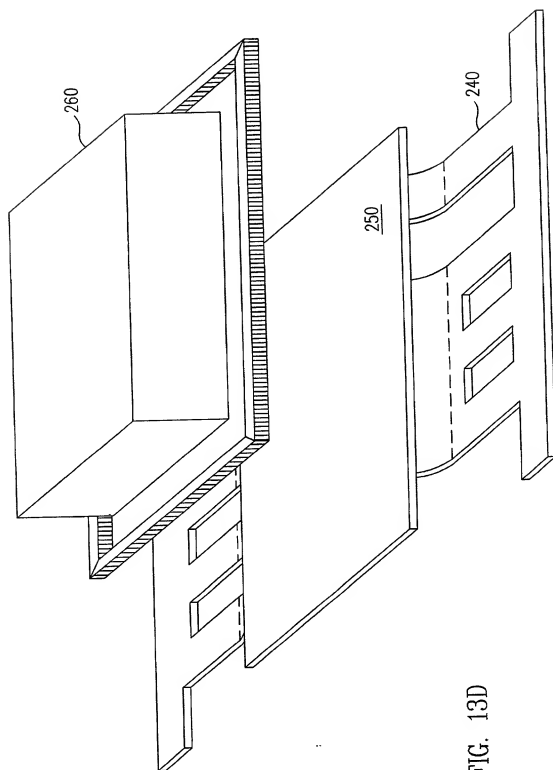
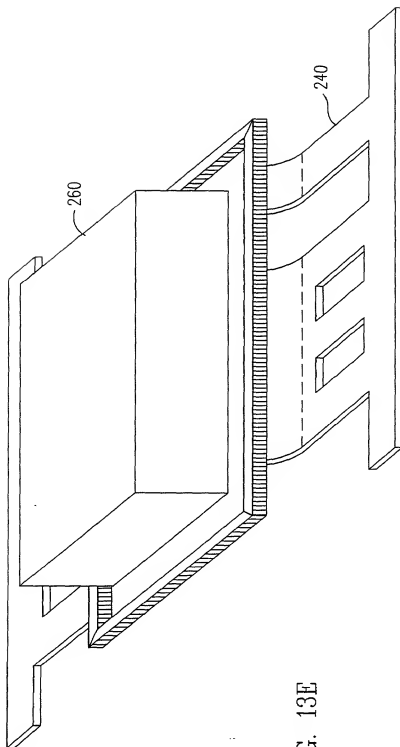


FIG. 13D



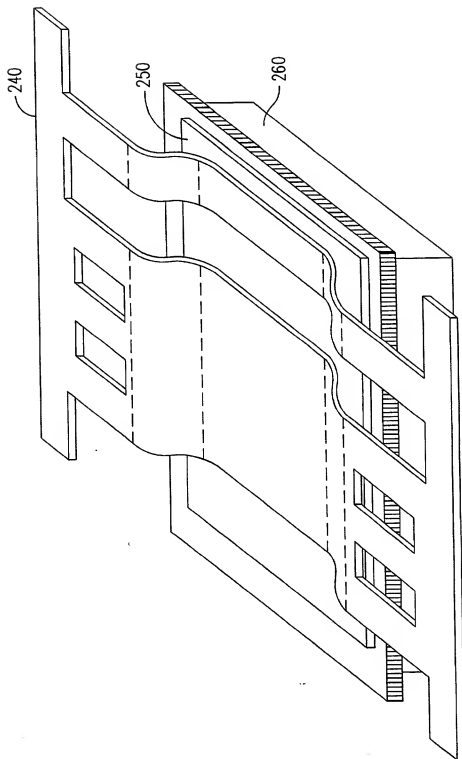


FIG. 13F